ORIENT DISPLAY

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SPECIFICATION
FOR
LCM MODULE

MODULE NO:AFS800480TG-5.0-D000001
REVISION NO: 01

Customer's Approval:

	SIGNATURE	DATE
PREPARED BY (RD ENGINEER)	XJZ	2011-12-8
CHECKED BY	YHW	2011-12-8
APPROVED BY	HSH	2011-12-8

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DOCUMENT REVISION HISTORY

Version	DATE	DESCRIPTION	CHANGED BY
00	Feb-02-2012	First Issue	Fr.li
01	Mar-07-2012	Changed “Dimensional Outline”	Fr.li

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1. Features & Mechanical Specifications

Item	Contents	Unit
	LCD	
LCD Type	TFT / Transmissive / Normally White	--
Viewing direction	6 O'clock	--
Backlight	White LED x 12	--
Interface	RGB-24bit parallel interface	--
Driver IC	ILI6123H & ILI5480	--
Outline Dimension	120.8(W) × 76.0(H) × 3.0(T)	mm
Glass area (W×H×T)	114.8 × 68.8 / 73.2 × 1.0	mm
Active area (W×H)	108 × 64.8	mm
Number of Dots	800(RGB)×480	--
Dot pitch (W×H)	0.135 × 0.135	mm
Pixel pitch (W×H)	0.045 × 0.135	mm
Operating Temperature	-20 ～ +70	℃
Storage temperature	-30 ～ +80	℃

2. Dimensional Outline

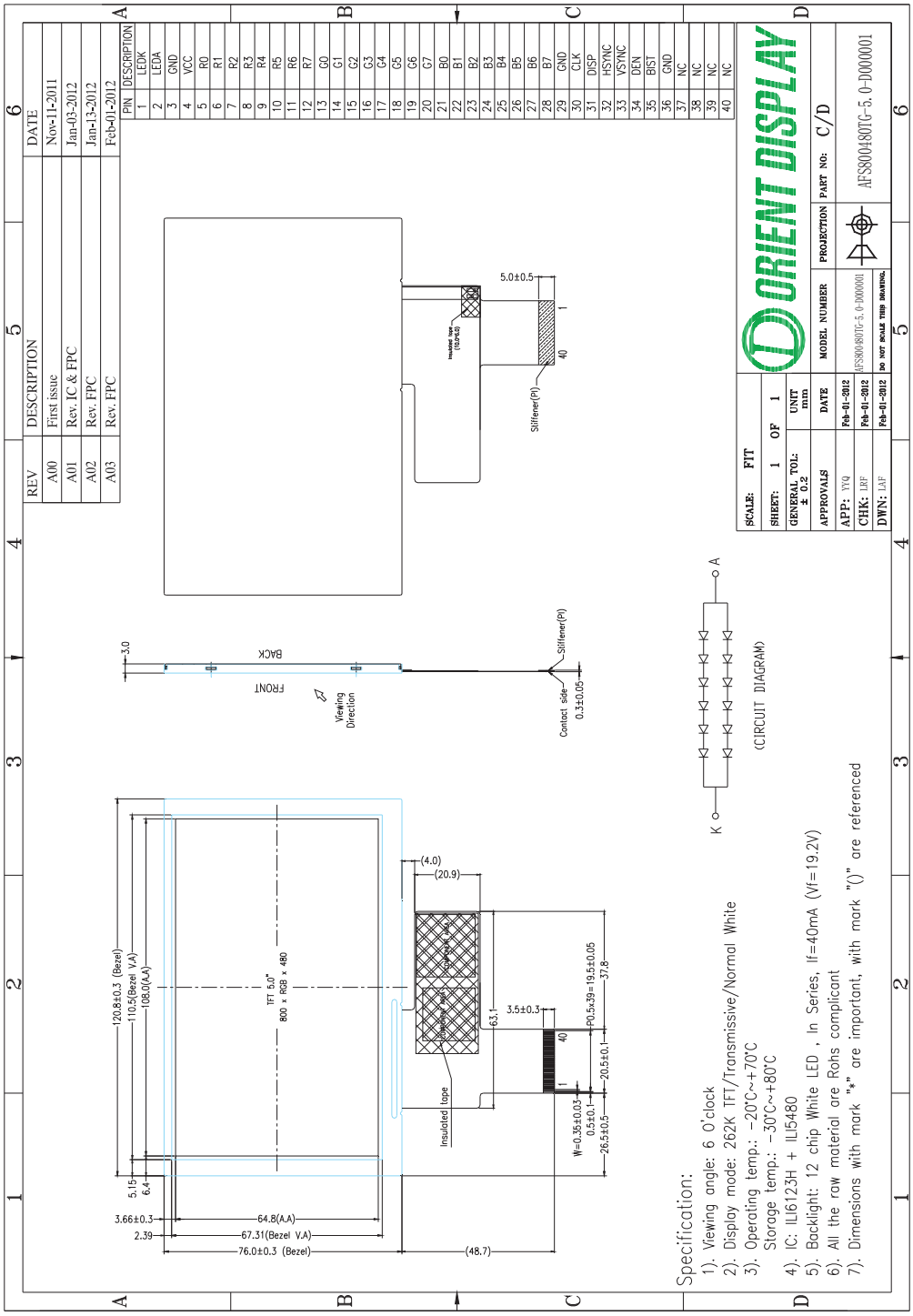


Figure 1. Dimensional outline

3. Block Diagram

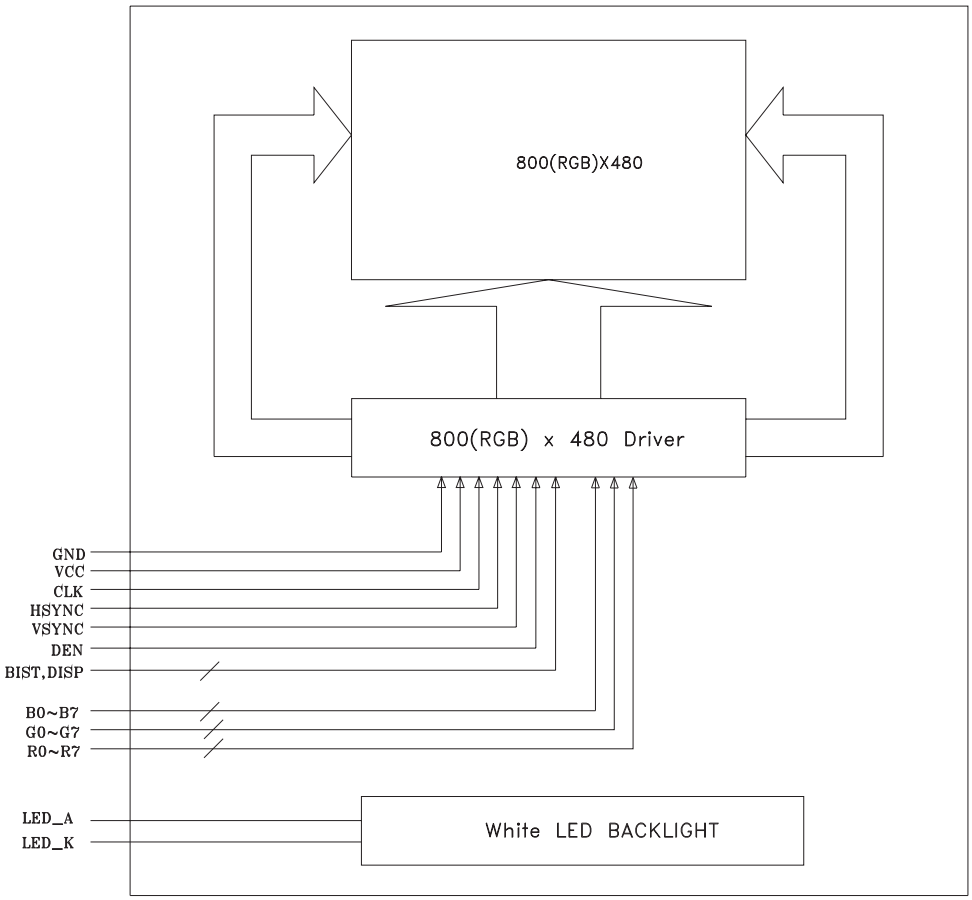


Figure 2. Block diagram

4. Pin Description

PIN No.	SYMBOL	Function
1	LED_K	LED Backlight Cathode
2	LED_A	LED Backlight Anode
3	GND	Ground
4	VCC	Power Supply
5~12	R0~R7	Red Data Input
13~20	G0~G7	Green Data Input
21~28	B0~B7	Blue Data Input
29	GND	Ground
30	CLK	Clock input
31	DISP	Standby mode control. STBYB="L", enter standby mode STBYB="H", normal operation
32	HSYNC	Horizontal sync input
33	VSYNC	Vertical sync input
34	DEN	Input data enable control
35	BIST	Normal operation / BIST pattern select. BIST="L", Normal operation BIST="H", BIST
36	GND	Ground
37	NC	No Connection
38	NC	No Connection
39	NC	No Connection
40	NC	No Connection

5. Absolute Maximum Ratings

Item	Symbol	Rating	Unit
Power supply	VDD	-0.5 to +5.0	V
Operating Temperature range	TOP	-20 to +70	℃
Storage Temperature range	TST	-30 to +80	℃

6. Electrical Characteristics

DC Characteristics

Item	Symbol	Min.	Type.	Max.	Unit
Digital Power Supply Voltage	VDD	3.0	3.3	3.6	V

7. Backlight Characteristics

(White LED × 6 in series) × 2 in Parallel **(Ta = 25°C)**

Item	Symbol	Condition	Min	Typ	Max	Unit
Forward Voltage	VF	IF=40mA	18	19.2	20.4	V
Uniformity	△Bp	-	80	-	-	%
Luminance for LCD	Lv	IF=40mA	4000	4400	-	cd/m^2

8. Electro-Optical Characteristics

Item		Symbol	Condition	Min.	Typ.	Max.	Unit	Note
Transmittance (With EWV PZ)		T		—	4.48	—	%	
Contrast		CR	Θ=0 Normal viewing angle	480	600	—		(1)(2)
Response time	Rising	T_R		—	2	4	msec	(1)(3)
	Falling	T_F		—	6	12		
Color gamut		S		—	50	—	%	C light
Color chromaticity (CIE1931)	White	W_x		0.295	0.310	0.325		(1)(4) CF Glass C light
		W_y		0.334	0.349	0.364		
	Red	Rx		0.611	0.626	0.641		
		Ry		0.331	0.346	0.361		
	Green	Gx		0.307	0.322	0.337		
		Gy		0.537	0.552	0.567		
	Blue	Bx		0.134	0.149	0.164		
		By		0.168	0.183	0.198		
Viewing angle (With EWV PZ)	Hor.	Θ_L	CR>10	65	75	—		
		Θ_R		65	75	—		
	Ver.	Θ_U		50	60	—		
		Θ_D		60	70	—		
Optima View Direction		6 O' clock						(5)

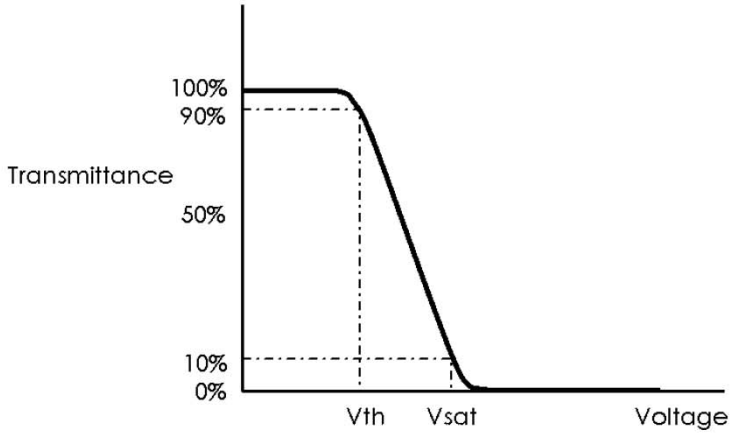
4.2 Measuring Condition

- Measuring surrounding: dark room
- Ambient temperature: 25±2°C
- 15min. warm-up time.

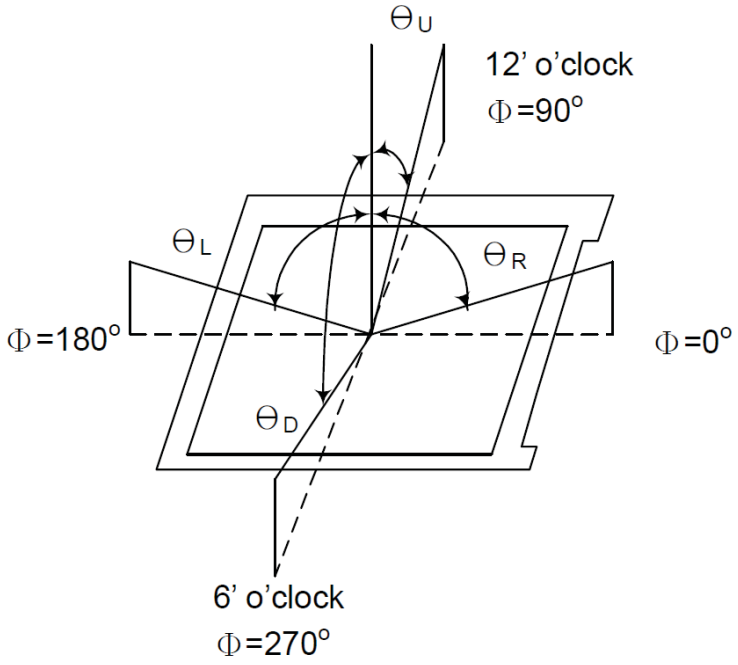
4.3 Measuring Equipment

- FPM520 of Westar Display technologies, INC., which utilized SR-3 for Chromaticity and BM-5A for other optical characteristics.
- Measuring spot size: 20 ~ 21 mm

Note (1) Definition of Vth and Vsat (at 20℃)



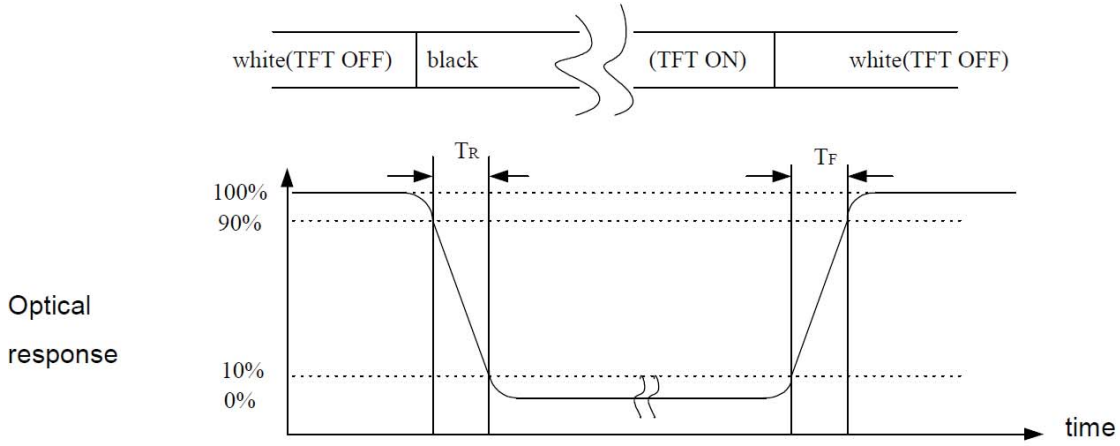
Note (2) Definition of Viewing Angle:



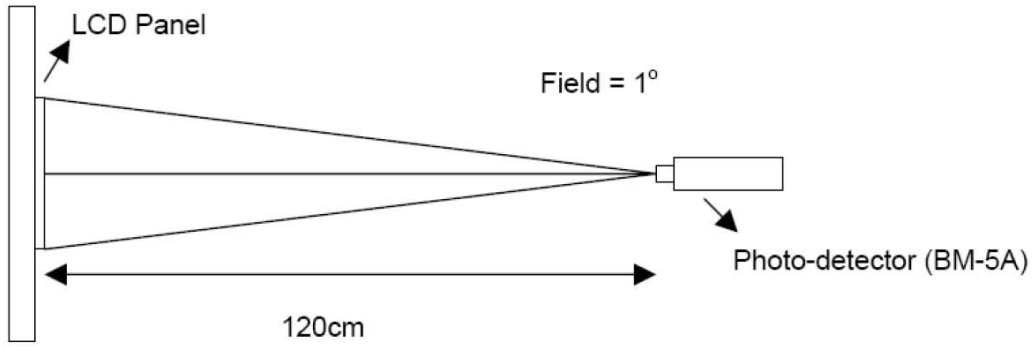
Note (3) Definition of Contrast Ratio (CR):
measured at the center point of panel

$$CR = \frac{\text{Luminance with all pixels white}}{\text{Luminance with all pixels black}}$$

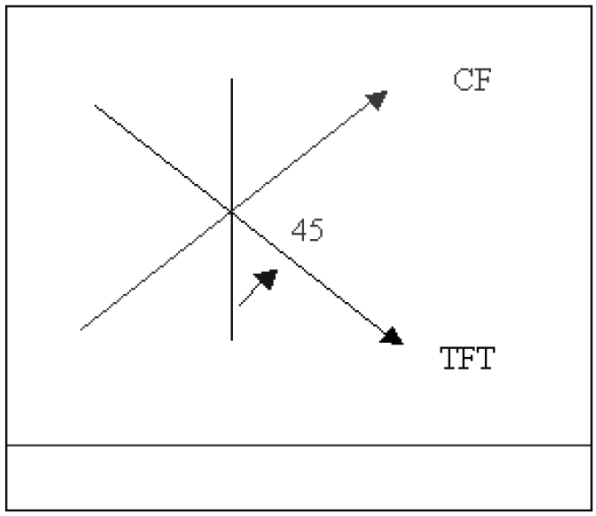
Note (4) Definition of Response Time : Sum of T_R and T_F



Note (5) Definition of optical measurement setup



Note (6) Rubbing Direction (The different Rubbing Direction will cause the different optima view direction.



(Alignment Direction)

9. AC Characteristics

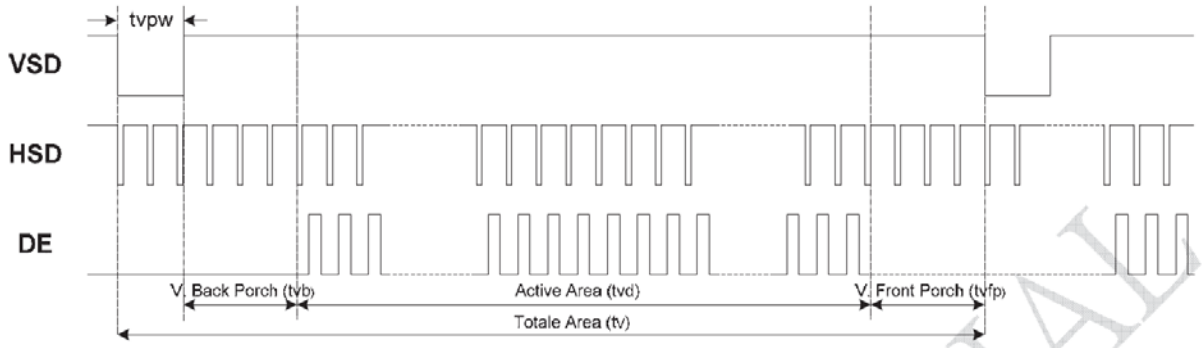
Horizontal input timing

Parameter		Symbol	Value			Unit	Note
Horizontal display area		thd		800		DCLK	
DCLK frequency		fclk	Min.	Typ.	Max.		
			-	33.3	50	MHz	
1 Horizontal Line		th		928		DCLK	
HSD pulse width	Min.	thpw		1			thb+thpw=88 DCLK is fixed.
	Typ.			48			
	Max.			-			
HSD Back Porch (Blanking)		thb	-	40	-		
HSD Front Porch		thfp	-	40	-		

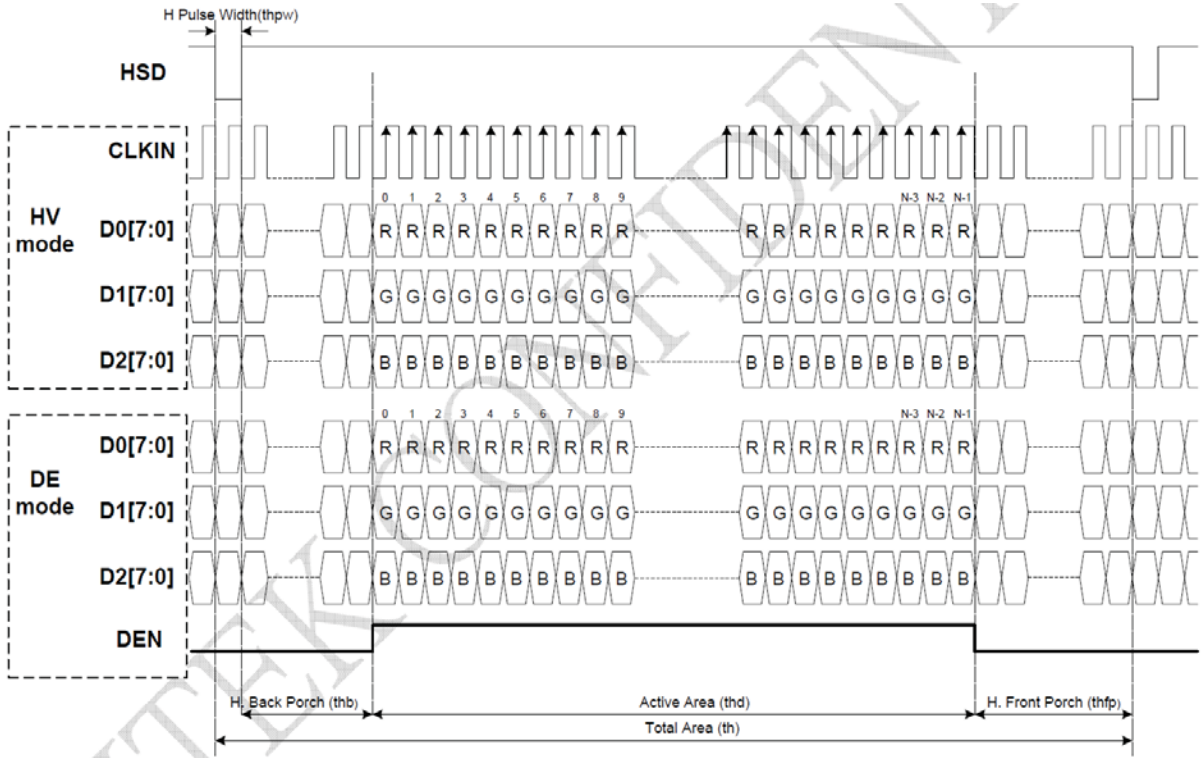
Vertical input timing

Parameter	Symbol	Value			Unit	Note
		Min.	Typ.	Max.		
Vertical display area	tvd		480		H	
VSD period time	tv	-	525	-	H	tvpw+tvb=32H Is fixed
VSD pulse width	tvpw	1	3	-	H	
VSD Back Porch (Blanking)	tvb	-	29	-	H	
VSD Front Porch	tvfp	-	13	-	H	

Vertical Input Timing



Horizontal Input Timing



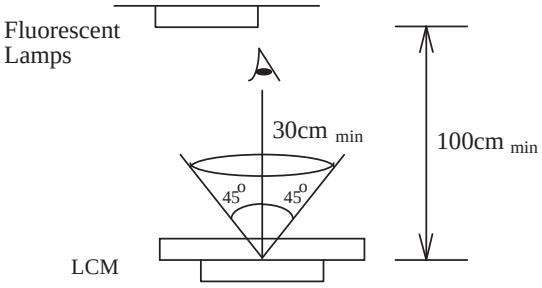
10.Quality Specifications

All The raw material are Rohs complicant.

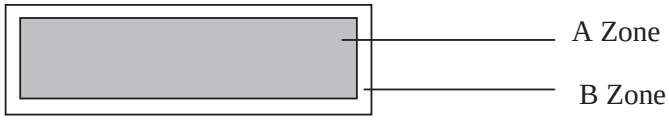
10.1 Standard of the product appearance test

Manner of appearance test: The inspection should be performed in using 20W x 2 fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is 45° from vertical against LCM.



Definition of zone:



A Zone: viewing area
B Zone: outside viewing area

10.2 Specification of quality assurance

AQL inspection standard

Sampling method: MIL-STD-105E, Level II, single sampling

Defect classification (Note: * is not including)

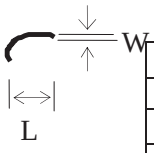
Classify	Item		Note	AQL
Major	Display state	Short or open circuit	1	0.65
		LC leakage		
		Flickering		
		No display		
		Wrong viewing direction		
		Contrast defect (dim, ghost)	2	
		Back-light	1,8	
	Non-display	Flat cable or pin reverse	10	
		Wrong or missing component	11	
Minor	Display state	Background color deviation	2	1.0
		Black spot and dust	3	
		Line defect, Scratch	4	
		Rainbow	5	
		Chip	6	
		Pin hole	7	
	Polarizer	Protruded	12	
		Bubble and foreign material	3	
	Soldering	Poor connection	9	
	Wire	Poor connection	10	
	TAB	Position, Bonding strength	13	

Note on defect classification

<table>
<tr><th>No.</th><th>Item</th><th>Criterion</th></tr>
<tr><td rowspan="6">1</td><td>Short or open circuit</td><td rowspan="6">Not allow</td></tr>
<tr><td>LC leakage</td></tr>
<tr><td>Flickering</td></tr>
<tr><td>No display</td></tr>
<tr><td>Wrong viewing direction</td></tr>
<tr><td>Wrong Back-light</td></tr>
<tr><td rowspan="2">2</td><td>Contrast defect</td><td rowspan="2">Refer to approval sample</td></tr>
<tr><td>Background color deviation</td></tr>
<tr><td>3</td><td>Point defect,
Black spot, dust
(including Polarizer)

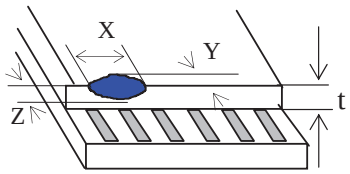
□ = (X+Y)/2</td><td> 

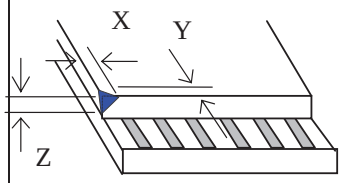
<table>
<tr><th>Point
Size</th><th>Acceptable Qty.</th></tr>
<tr><td>□≦0.10</td><td>Disregard</td></tr>
<tr><td>0.10□□≦0.20</td><td>3</td></tr>
<tr><td>0.20□□≦0.25</td><td>2</td></tr>
<tr><td>0.25□□≦0.30</td><td>1</td></tr>
<tr><td>□>0.30</td><td>0</td></tr>
</table>
Unit：mm</td></tr>
<tr><td>4</td><td>Line defect,

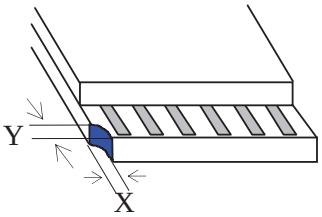
Scratch</td><td> 

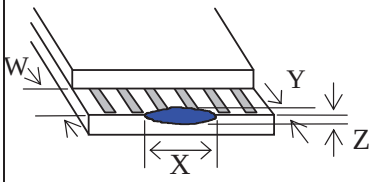
<table>
<tr><th colspan="2">Line</th><th>Acceptable Qty.</th></tr>
<tr><td>L</td><td>W</td><td></td></tr>
<tr><td>---</td><td>0.02≧W</td><td>Disregard</td></tr>
<tr><td>4.0≧L</td><td>0.03≧W>0.02</td><td rowspan="2">2</td></tr>
<tr><td>2.0≧L</td><td>0.05≧W>0.03</td></tr>
<tr><td>1.0≧L</td><td>0.1＞W>0.05</td><td>1</td></tr>
<tr><td>---</td><td>0.1□W</td><td>Applied as point defect</td></tr>
</table>
Unit: mm</td></tr>
<tr><td>5</td><td>Rainbow</td><td>Not more than two color changes across the viewing area.</td></tr>
</table>

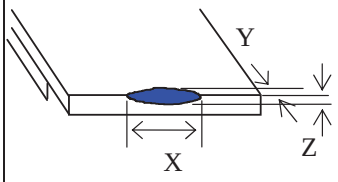
<table>
<tr><th>No</th><th>Item</th><th>Criterion</th></tr>
<tr><td>6</td><td>Chip

Remark:
X: Length direction
Y: Short direction
Z: Thickness direction
t: Glass thickness
W: Terminal Width</td><td>


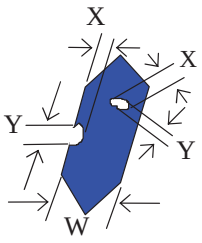
Acceptable criterion
<table>
<tr><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>≤2</td><td>0.5mm</td><td>≤t/2</td></tr>
</table>


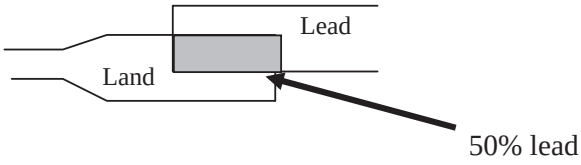
Acceptable criterion
<table>
<tr><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>≤2</td><td>0.5mm</td><td>≤t</td></tr>
</table>


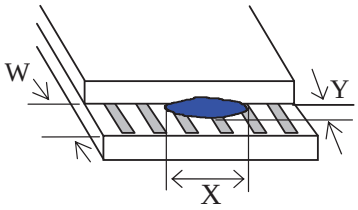
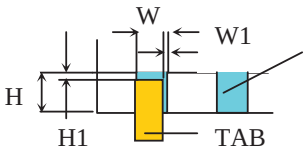
Acceptable criterion
<table>
<tr><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>≤3</td><td>≤2</td><td rowspan="2">≤t</td></tr>
<tr><td colspan="2">shall not reach to ITO</td></tr>
</table>


Acceptable criterion
<table>
<tr><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>Disregard</td><td>≤0.2</td><td>≤t</td></tr>
</table>


Acceptable criterion
<table>
<tr><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>≤5</td><td>≤2</td><td>≤t/3</td></tr>
</table>
</td></tr>
</table>

<table>
<tr><th>No.</th><th>Item</th><th>Criterion</th></tr>
<tr><td>7</td><td>Segment
pattern
W = Segment width
□ = (X+Y)/2</td><td>(1) Pin hole
□ < 0.10mm is acceptable.
 

<table>
<tr><th>Point Size</th><th>Acceptable Qty</th></tr>
<tr><td>□≤1/4W</td><td>Disregard</td></tr>
<tr><td>1/4W□□≤1/2W</td><td>1</td></tr>
<tr><td>□>1/2W</td><td>0</td></tr>
</table>
Unit: mm</td></tr>
<tr><td>8</td><td>Back-light</td><td>(1) The color of backlight should correspond its specification.
(2) Not allow flickering</td></tr>
<tr><td>9</td><td>Soldering</td><td>(1) Not allow heavy dirty and solder ball on PCB.
(The size of dirty refer to point and dust defect)
(2) Over 50% of lead should be soldered on Land.
 
</td></tr>
<tr><td>10</td><td>Wire</td><td>(1) Copper wire should not be rusted
(2) Not allow crack on copper wire connection.
(3) Not allow reversing the position of the flat cable.
(4) Not allow exposed copper wire inside the flat cable.</td></tr>
<tr><td>11*</td><td>PCB</td><td>(1) Not allow screw rust or damage.
(2) Not allow missing or wrong putting of component.</td></tr>
</table>

No	Item	Criterion
12	Protruded W: Terminal Width	 Acceptable criteria: Y ≤ 0.4
13	TAB	1. Position  W1≤1/3W H1≤1/3H 2 FPC bonding strength test  P (=F/FPC bonding width) ≥650gf/cm ,(speed rate: 1mm/min) 5pcs per SOA (shipment)
14	Total no. of acceptable Defect	A. Zone Maximum 2 minor non-conformities per one unit. Defect distance: each point to be separated over 10mm B. Zone It is acceptable when it is no trouble for quality and assembly in customer's end product.

10.3 Reliability of LCM

Reliability test condition:

Item	Condition	Time (hrs)	Assessment
High temp. Storage	60℃	48	No abnormalities in functions and appearance
High temp. Operating	50℃	48	
Low temp. Storage	-10℃	48	
Low temp. Operating	0℃	48	
Humidity	40℃/ 90%RH	48	
Temp. Cycle	-10℃ → 25℃ → 60℃ (60 min → 5 min → 60min)	10cycles	

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature (20±8℃), normal humidity (below 65% RH), and in the area not exposed to direct sun light.

10.4 Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

General Precautions:

1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
3. Do not tamper in any way with the tabs on the metal frame.
4. Do not made any modification on the PCB without consulting OD
5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

Static Electricity Precautions:

1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
5. Only properly grounded soldering irons should be used.
6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
7. The normal static prevention measures should be observed for work clothes and working benches.
8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

Soldering Precautions:

1. Soldering should be performed only on the I/O terminals.
2. Use soldering irons with proper grounding and no leakage.
3. Soldering temperature: 280°C $\pm$10°C
4. Soldering time: 3 to 4 second.
5. Use eutectic solder with resin flux filling.
6. If flux is used, the LCD surface should be protected to avoid spattering flux.
7. Flux residue should be removed.

Operation Precautions:

1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
4. Response time increases with decrease in temperature.
5. Display color may be affected at temperatures above its operational range.
6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

Limited Warranty

OD LCDs and modules are not consumer products, but may be incorporated by OD's customers into consumer products or components thereof, OD does not warrant that its LCDs and components are fit for any such particular purpose.

1. The liability of OD is limited to repair or replacement on the terms set forth below. OD will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between OD and the customer, OD will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with OD general LCD inspection standard. (Copies available on request)
2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.